

# RJF0604JPD

Silicon N Channel MOS FET Series Power Switching R07DS0583EJ0100 Rev.1.00 Nov 22, 2011

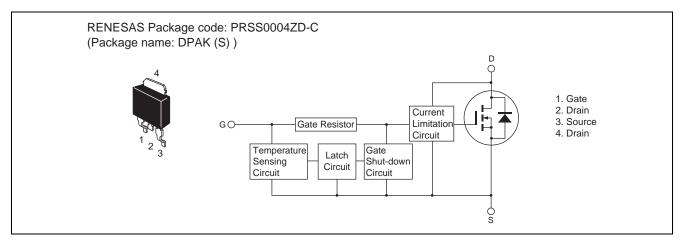
## Description

This FET has the over temperature shut-down capability sensing to the junction temperature. This FET has the built-in over temperature shut-down circuit in the gate area. And this circuit operation to shut-down the gate voltage in case of high junction temperature like applying over power consumption, over current etc..

#### Features

- Logic level operation (5 V Gate drive).
- Built-in the over temperature shut-down circuit.
- High endurance capability against to the short circuit.
- Latch type shut down operation (need 0 voltage recovery).
- Built-in the current limitation circuit.
- Power supply voltage applies 12 V and 24 V.
- AEC-Q101 Compliant

#### Outline



## **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Ratings	Unit
Drain to source voltage	V <sub>DSS</sub>	60	V
Gate to source voltage	V <sub>GSS</sub>	16	V
Gate to source voltage	V <sub>GSS</sub>	-2.5	V
Drain current	I <sub>D</sub> <sup>Note3</sup>	5	А
Body-drain diode reverse drain current	I <sub>DR</sub>	5	А
Avalanche current	I <sub>AP</sub> Note 2	(4.7)	А
Avalanche energy	E <sub>AR</sub> <sup>Note 2</sup>	(94.7)	mJ
Channel dissipation	Pch Note 1	30	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. Value at Tc = 25°C

2. Tch =  $25^{\circ}$ C, Rg  $\geq 50 \Omega$ 

3. It provides by the current limitation lower bound value.



# **Typical Operation Characteristics**

						$(Ta = 25^{\circ}C)$
ltem	Symbol	Min	Тур	Max	Unit	Test Conditions
Input voltage	V <sub>IH</sub>	3.5	—	—	V	
	V <sub>IL</sub>	—	—	1.2	V	
Input current	I <sub>IH1</sub>		—	100	μΑ	Vi = 8 V, V <sub>DS</sub> = 0
(Gate non shut down)	I <sub>IH2</sub>		—	50	μΑ	$Vi = 3.5 V, V_{DS} = 0$
	IIL		—	1	μΑ	Vi = 1.2 V, V <sub>DS</sub> = 0
Input current	I <sub>IH(sd)1</sub>		0.8	—	mA	$Vi = 8 V, V_{DS} = 0$
(Gate shut down)	I <sub>IH(sd)2</sub>		0.35	—	mA	$Vi = 3.5 V, V_{DS} = 0$
Shut down temperature	Tsd		175	—	°C	Channel temperature
Gate operation voltage	Vop	3.5	_	12	V	
Drain current (Current limitation value)	I <sub>D limt</sub>	(5)	—	—	A	$V_{GS} = 5 V, V_{DS} = 10 V^{Note 4}$

Note; 4. Pulse test

#### **Electrical Characteristics**

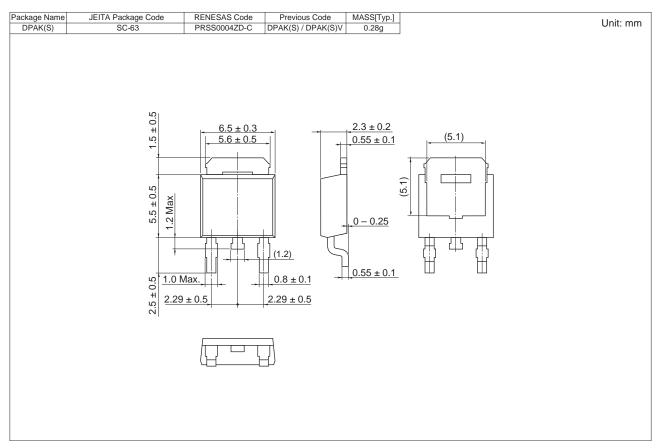
			-			$(Ta = 25^{\circ}C)$
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain current	I <sub>D1</sub>	_	—	(17)	A	$V_{GS}$ = 3.5 V, $V_{DS}$ = 10 V <sup>Note 5</sup>
	I <sub>D2</sub>	—	—	(10)	mA	$V_{GS} = 1.2 \text{ V}, V_{DS} = 10 \text{ V}$
	I <sub>D3</sub>	(5)	—	—	A	$V_{GS} = 5 \text{ V}, \text{ V}_{DS} = 10 \text{ V}^{Note 5}$
Drain to source breakdown voltage	V <sub>(BR)DSS</sub>	60	_		V	$I_{D} = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown	V <sub>(BR)GSS</sub>	16	—	—	V	$I_{G} = 800 \ \mu A, \ V_{DS} = 0$
voltage	V <sub>(BR)GSS</sub>	-2.5	_	_	V	$I_{G} = -100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I <sub>GSS1</sub>	_	_	100	μA	$V_{GS} = 8 V, V_{DS} = 0$
	I <sub>GSS2</sub>		_	50	μΑ	$V_{GS} = 3.5 \text{ V}, V_{DS} = 0$
	I <sub>GSS3</sub>	_	—	1	μΑ	$V_{GS} = 1.2 \text{ V}, V_{DS} = 0$
	I <sub>GSS4</sub>	_	_	-100	μΑ	$V_{GS} = -2.4 \text{ V}, V_{DS} = 0$
Input current (shut down)	I <sub>GS(OP)1</sub>	_	0.8		mA	$V_{GS} = 8 V, V_{DS} = 0$
	I <sub>GS(OP)2</sub>	_	0.35		mA	$V_{GS} = 3.5 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I <sub>DSS1</sub>	_	_	10	μA	$V_{DS} = 32 V, V_{GS} = 0$
	I <sub>DSS2</sub>	_	_	(10)	μA	$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0, \text{ Ta} = 110^{\circ}\text{C}$
Gate to source cutoff voltage	V <sub>GS(off)</sub>	(1.2)	_	(2.4)	V	$V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}$
Forward transfer admittance	y <sub>fs</sub>	(4)	(7.6)	—	S	$I_D = 2.5 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note 5}}$
Static drain to source on state	R <sub>DS(on)</sub>	_	(76)	100	mΩ	$I_D = 2.5 \text{ A}, V_{GS} = 4 \text{ V}^{\text{Note 5}}$
resistance	R <sub>DS(on)</sub>	_	(51)	(75)	mΩ	$I_D = 2.5 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note 5}}$
Output capacitance	Coss	_	(280)	—	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0, f = 1 \text{MHz}$
Turn-on delay time	t <sub>d(on)</sub>	_	(4.1)	—	μS	$V_{GS}$ = 5 V, $I_D$ = 2.5 A, $R_L$ = 12 $\Omega$
Rise time	tr	_	(16)	—	μS	
Turn-off delay time	t <sub>d(off)</sub>	_	(2.5)	—	μS	
Fall time	t <sub>f</sub>	_	(3.1)	—	μS	
Body-drain diode forward voltage	V <sub>DF</sub>	_	(0.84)	—	V	$I_F = 5 A, V_{GS} = 0$
Body-drain diode reverse recovery time	t <sub>rr</sub>		(100)	—	ns	$I_F = 5 \text{ A}, V_{GS} = 0$ $di_F/dt = 50 \text{ A}/\mu\text{s}$
Over load shut down	t <sub>os1</sub>	_	(1.2)	—	ms	$V_{GS} = 5 V, V_{DD} = 16 V$
operation time Note 6	t <sub>os2</sub>		(0.7)	—	ms	$V_{GS} = 5 V, V_{DD} = 24 V$

Notes: 5. Pulse test

6. Including the junction temperature rise of the over loaded condition.



## **Package Dimensions**



## **Ordering Information**

Orderable Part Number	Quantity	Shipping Container		
RJF0604JPD-00#J3	3000 pcs	Taping		

Note: The symbol of a "#" are occasionally presented as a "-".



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